

Description

The **NA-FFA381-A10-1** is a high SNR, small package, single-ended output top port analog MEMS microphone, consists of a MEMS sensor and a low noise level ASIC.

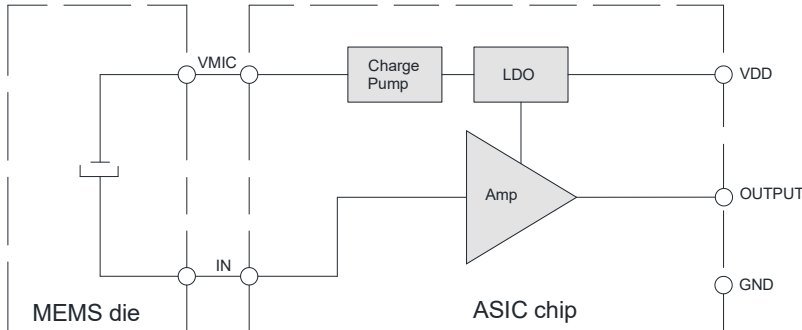
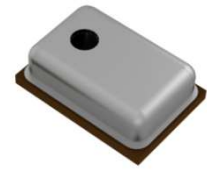
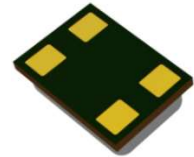


Fig. 1 Microphone block diagram



Top View



Bottom View

Key Features

- ✧ 2.75x1.85x1.0mm Top Port
- ✧ Small Package
- ✧ High SNR
- ✧ Narrow Sensitivity +/-1dB
- ✧ RF Shielded
- ✧ Compatible with Standard SMD Reflow Technology
- ✧ RoHS Compliance & Halogen Free

Typical Applications

- ✧ TWS Earphone
- ✧ Wireless Headsets
- ✧ Smart Speakers
- ✧ Wearable Electronics
- ✧ Portable Electronics
- ✧ Smart Home Electronics

Maximum Ratings

Stresses at the maximum ratings shown in Table 1 may cause permanent damage to the device. These are stress ratings only at which the device may not function when an operation at these or any other condition beyond those specified under “Electro-Acoustic Specifications”.

Table 1 Maximum Ratings

| Parameter | Maximum Ratings | Unit |
|-----------------------------|-----------------|------|
| Supply voltage | 4.2 | V |
| Operation temperature range | -40~85 | °C |
| Storage temperature range | -40~100 | °C |

Electro-Acoustic Specifications

Table 2 Electrical Specifications

Test condition: +25±2°C, 60%~70%RH, 86~106Kpa, Vdd=2V, no load, unless otherwise specified.

| No. | Parameter | Symbol | Condition | Min. | Nom. | Max. | Unit |
|-----|----------------------------------|-------------------|---|-------------------------|------|------|-------|
| 1 | Sensitivity | S | f=1KHz, Pin=1Pa, 0dB=1V/Pa | -39 | -38 | -37 | dB |
| 2 | Operating Voltage | V _{DD} | | 1.6 | 2 | 3.6 | V |
| 3 | Directivity | | | Omni-directional | | | |
| 4 | Polarity | | Sound pressure increase | Output voltage increase | | | |
| 5 | Sensitivity vs. Voltage | ΔS | Vs= 3.6V to 1.6V | <0.5 | | | dB |
| 6 | Output Impedance | Z _{OUT} | f=1KHz | | | 400 | Ω |
| 7 | Current Consumption ¹ | I | 1.6 V to 3.6V | | 120 | 200 | μA |
| 8 | S/N Ratio | S/N | A-Weighted | 62 | 64 | | dBA |
| 9 | Total Harmonic Distortion | THD | 94dBSPL@1KHz | | 0.05 | 0.5 | % |
| | | | 123dBSPL@1KHz | | 1 | | |
| 10 | Acoustic Overload Point | AOP | THD 10%@1KHz | | 127 | | dBSPL |
| 11 | Power Supply Rejection | PSR | 100mVpp Square-wave @217Hz, A-weighted | | -105 | -95 | dB |
| 12 | Power Supply Rejection Ratio | PSRR | 200mVpp Sinewave @1KHz | 60 | 72 | | dB |
| 13 | DC output | VDC | | | 0.85 | | V |
| 14 | Output load | C _{load} | | | | 100 | pF |
| | | R _{load} | | 8 | | | K Ω |

Note: Frequency response, sensitivity and current consumption are tested by 100% on product line.

Performance Curves

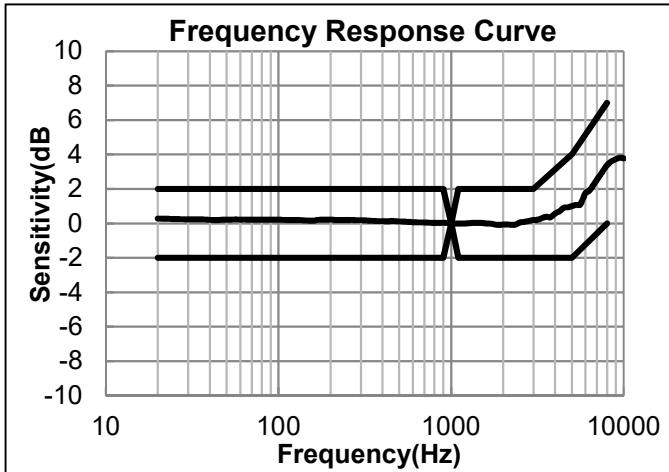


Fig. 2 Frequency response curve normalized to 1KHz

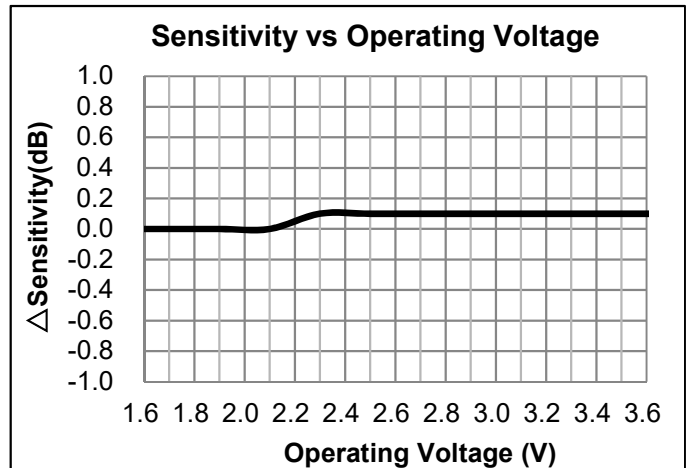


Fig. 3 Sensitivity vs Operating Voltage

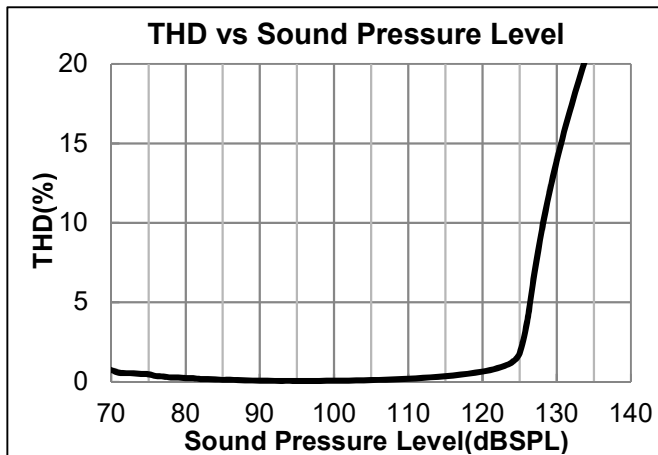


Fig. 4 Typical THD vs Sound Pressure Level

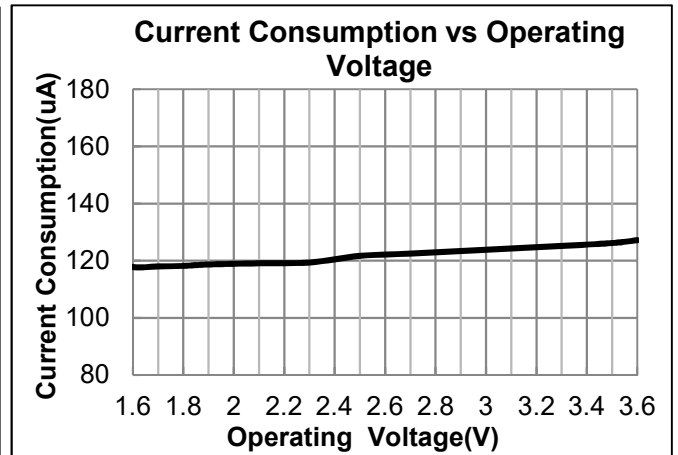


Fig. 5 Typical Current vs Operating Voltage

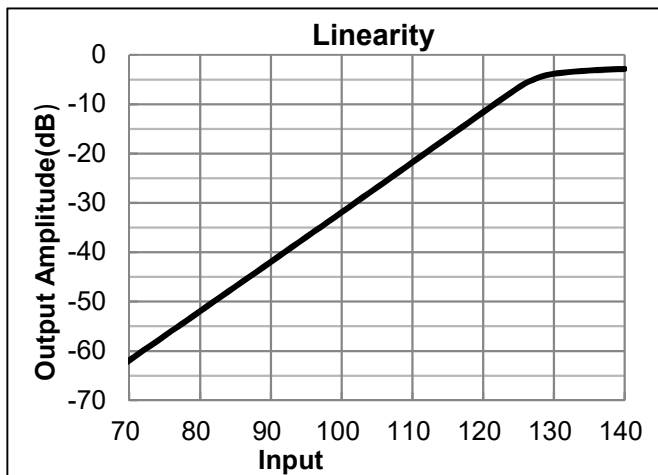


Fig. 6 Linearity

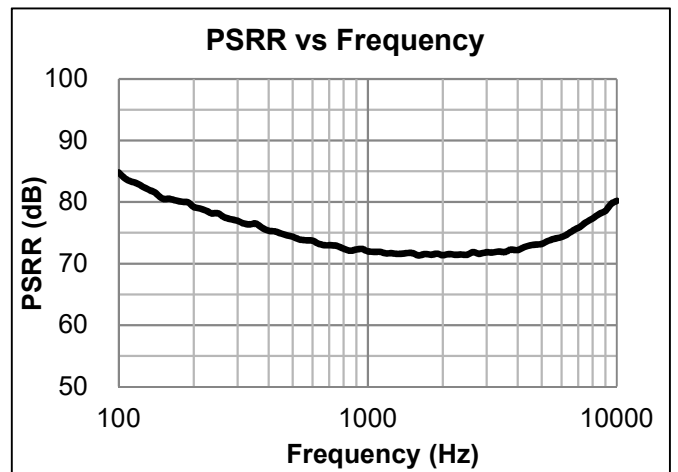


Fig. 7 Typical PSRR curve

Measurement System Setup

Test signal: Sinusoid, Sweep,

Step: 1/12 octave

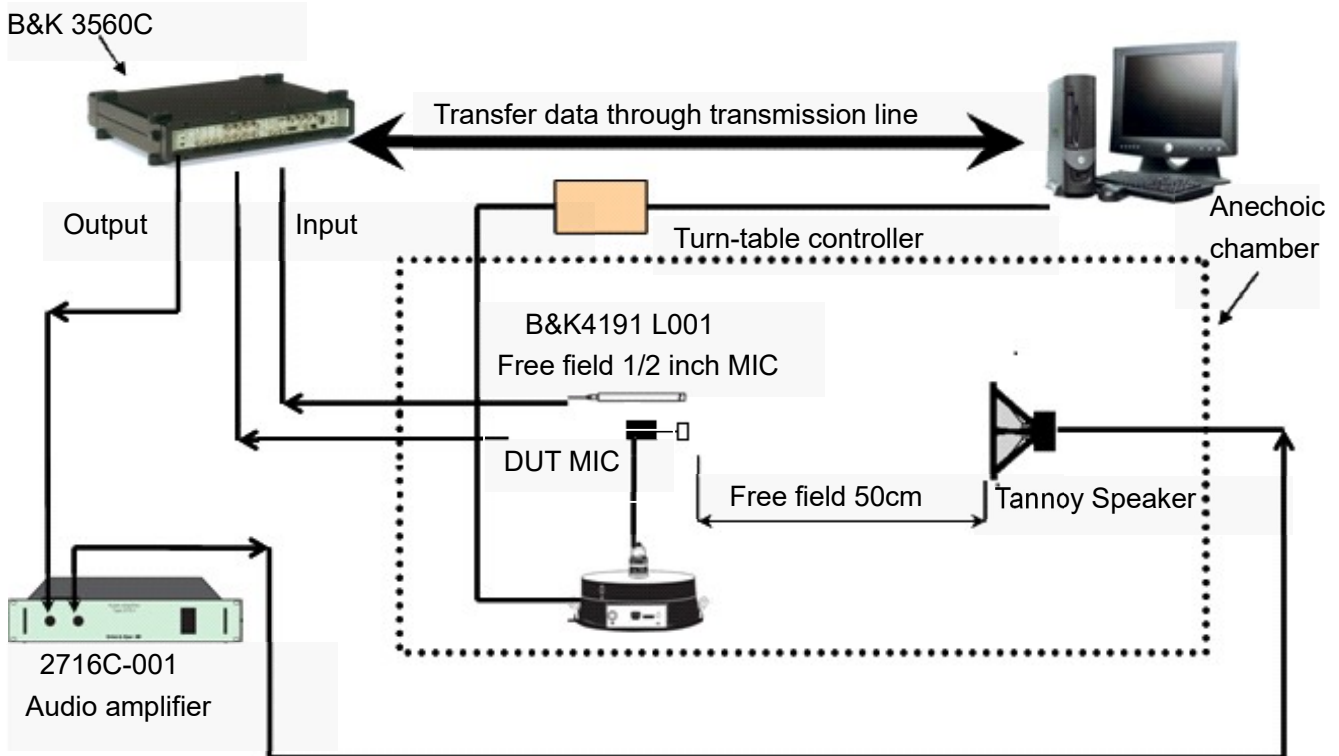


Fig. 8 Measurement System Setup

Typical Application Circuit

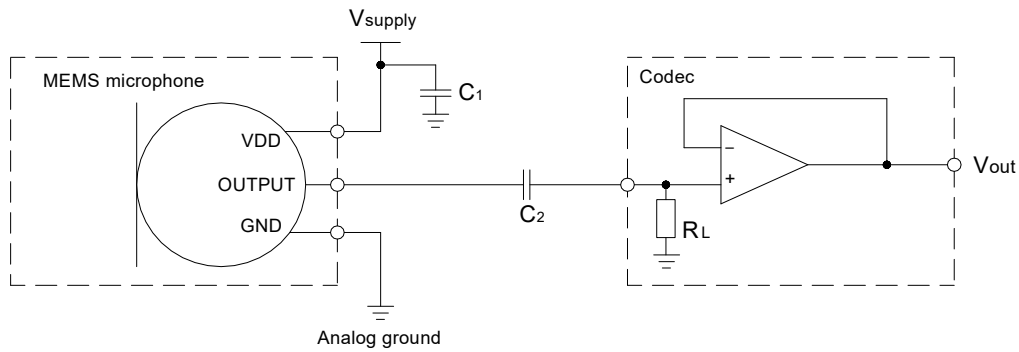


Fig. 9 Typical Application Circuit

Power supply decoupling:

A 0.1uF ceramic type decoupling capacitor C_1 is strongly recommended for every microphone and it should be placed as close to the VDD pad to reduce the noise on power supply;

The trace connected to each pad of capacitor should be as short as possible, and should stay on one layer of PCB without via. For the best performance, recommend to place the capacitor equidistance from power and ground pins of microphone, or slightly closer to the power pin if space not allowed. System ground should connect to far side of the capacitor, as shown in fig.10.

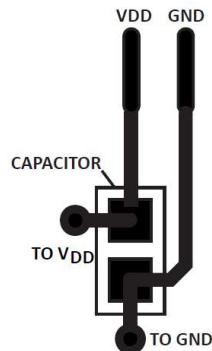


Fig. 10 Recommended Power Supply Decoupling Capacitor Layout

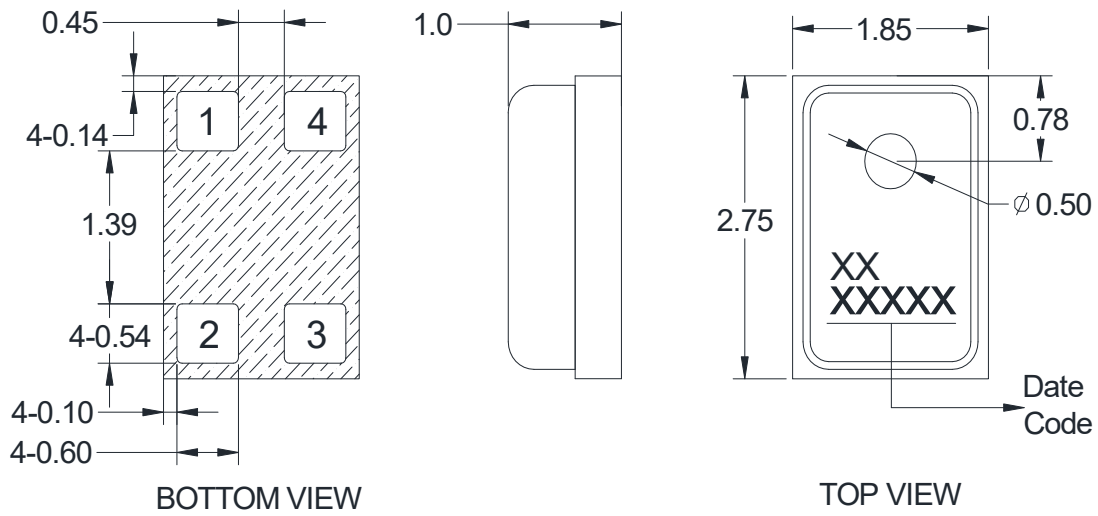
Low frequency roll-off:

DC-blocking capacitor C_2 is required on the output signal line. The 3-dB cut-off frequency can be calculated using follow equation which is related to DC-blocking capacitor C_2 and input resistance of the differential input amplifier.

$$3\text{dB cut-off frequency} = 1/2\pi R_L C_2$$

In order to get a cut-off frequency below 20 Hz, minimum 1uF value of C_2 minimum 20KΩ value of input resistance of the differential input amplifier is recommended.

Mechanical Specifications



Unit: mm Unmarked Tolerance: ± 0.1 (mm)

Fig. 11 Dimension

| Item | Dimension | Tolerance | PIN | Definition | Description |
|---------------|-----------|------------|-----|------------|---------------|
| Length | 2.75 | ± 0.1 | 1 | VDD | Power Supply |
| Width | 1.85 | ± 0.1 | 2 | GND | Ground |
| Height | 1.0 | ± 0.1 | 3 | GND | Ground |
| Acoustic Port | 0.50 | ± 0.05 | 4 | Output | Output Signal |

Note:

- All Ground Pin must be connected to the ground in end application
- Identification Marking

XX — Serial Number

XXXXX

Lot Number
 Day
 Month
 Year

Reliability Specifications

After conducting any of the following tests, the sensitivity change of DUT shall be less than $\pm 3\text{dB}$ from its initial value unless otherwise noted, and shall keep its initial operation and appearance.

Table 3 Reliability Specifications

| No. | Item | Test condition |
|-----|--------------------------------|---|
| 1 | Hi-Temperature Test | Temperature: $+85^{\circ}\text{C}$ Duration: 240 hours |
| 2 | Low-Temperature Test | Temperature: -40°C Duration: 240 hours |
| 3 | Humidity & Heat operating Test | Temperature: $+70^{\circ}\text{C}$ Humidity: 93% RH Duration: 240 hours |
| 4 | Thermal Shocking Test | Temperature & Duration: -40°C , 30 minutes Temperature & Duration: $+80^{\circ}\text{C}$, 30 minutes, Cycles: 32 cycles |
| 5 | Vibration Test | Frequency: 10-55Hz Amplitude: 1.52mm Direction: 2 directions Duration: 2 hours |
| 6 | Drop Test | Drop the microphones to the floor without package. Height: 1.5m Reference Surface: slippery marble floor Duration: 5 times |
| 7 | Electrostatic Discharge | The tests are performed acc. to IEC61000-4-2 level 3: a. Contact Discharge Discharge Position: Output of Microphone Charge Voltage: $\pm 6000\text{VDC}$ Discharge Network: 150pF & 330 Ω b. Air Discharge Discharge Position: Sound Hole Charge Voltage: $\pm 8000\text{VDC}$ Discharge Network: 150pF & 330 Ω |

Packaging Details

- * Use ESD reel and tape for microphone packaging.
- * Anti-static measures should be applied during packaging operation.

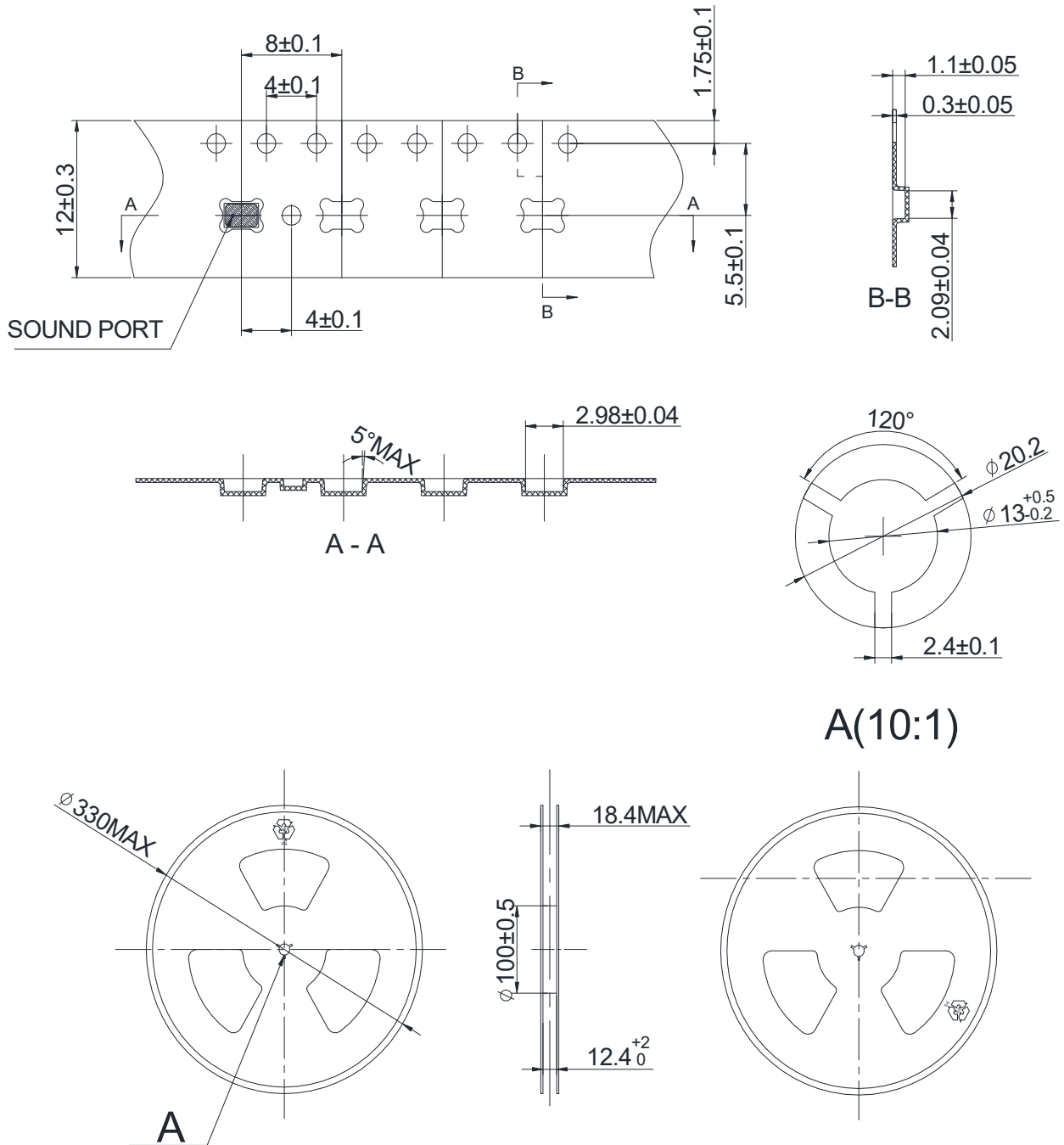
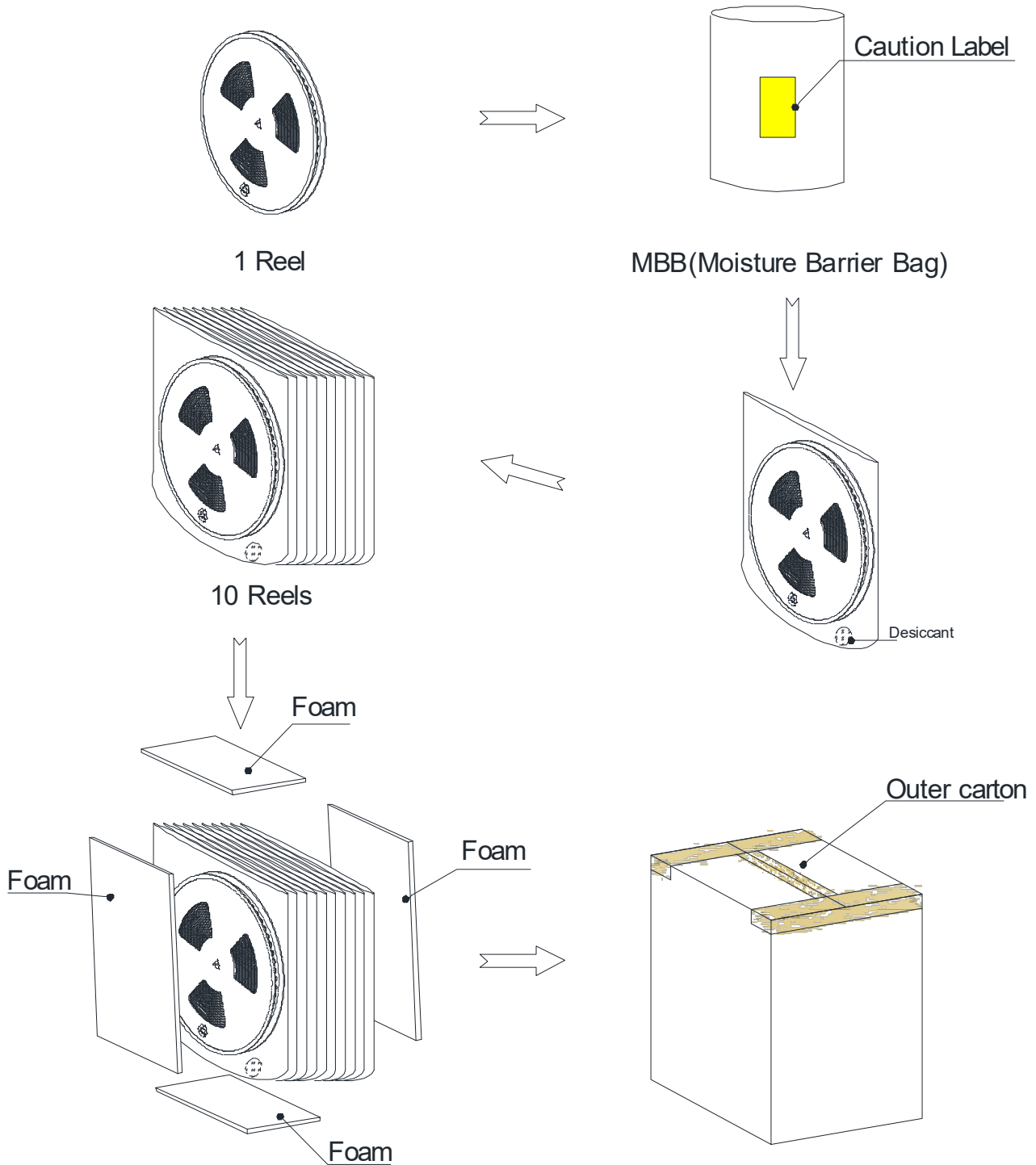


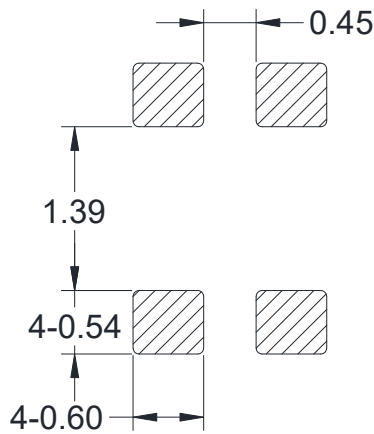
Fig. 12 Packaging



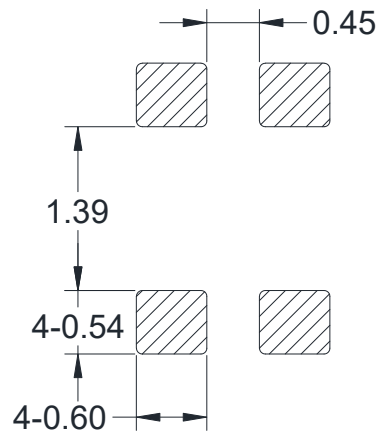
| | | |
|---------------|-------------------|-----------------------|
| Tape and Reel | φ330mm | 5,500PCS×1=5,500PCS |
| Shipping Box | 215mm*370mm*370mm | 5,500PCS×10=55,000PCS |

Application Design Suggestions

Recommended PCB and Stencil Design Pattern



Example Land Pattern



Example Solder Stencil Pattern

Notes:

- Dimensions are in millimeters unless otherwise specified.
- Tolerance is $\pm 0.1\text{mm}$ unless otherwise specified.

Temperature Profile during Reflow Process

Table 4 Temperature Profile during Reflow Process

| Parameter | | Reference | Specification |
|---|-------------------------------|---------------------|-------------------|
| Average Ramp Rate | | T_L to T_P | 3°C/sec max |
| Preheat | Minimum Temperature | T_{SMIN} | 150°C |
| | Maximum Temperature | T_{SMAX} | 200°C |
| | Time T_{SMIN} to T_{SMAX} | t_s | 60 sec to 180 sec |
| Ramp-Up Rate | | T_{SMAX} to T_L | 1.25°C/sec |
| Time Maintained Above Liquidous | | t_L | 60 sec to 150 sec |
| Liquidous Temperature | | T_L | 217°C |
| Peak Temperature | | T_P | 260°C |
| Time Within +5°C of Actual Peak Temperature | | t_P | 20 sec to 40 sec |
| Ramp-Down Rate | | T_P to T_{SMAX} | 6°C/sec max |
| Time +25°C ($t_{25^\circ\text{C}}$) to Peak Temperature | | | 8 min max |

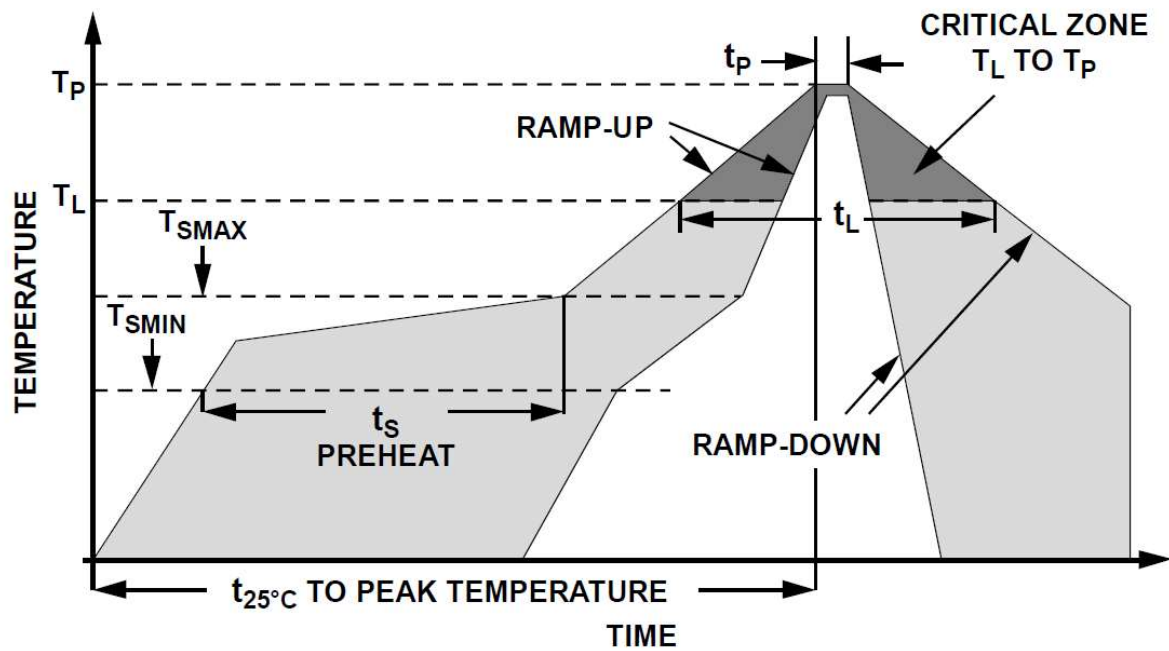


Fig. 13 Reflow Profile

Additional Notes:

- Mic should cool to room temp before next flow cycle if more reflow is needed.
- No more than 3 times reflow is recommended.
- Do not board wash by liquid or ultrasonic after the reflow process.
- Do not pull a vacuum over port hole of the microphone.
- Do not insert any object in port hole of device at any time.
- Suggest SMT the microphone at last time if double side PCBA used.
- Do not seal sound port during reflow .
- If there is any leakage risk, the peak temperature should be set to less than 240°C or more than 255°C.

Recommended nozzle for reflow MIC

External diameter is $\Phi 1.3\text{mm}$

Inside diameter is $\Phi 1.0\text{mm}$

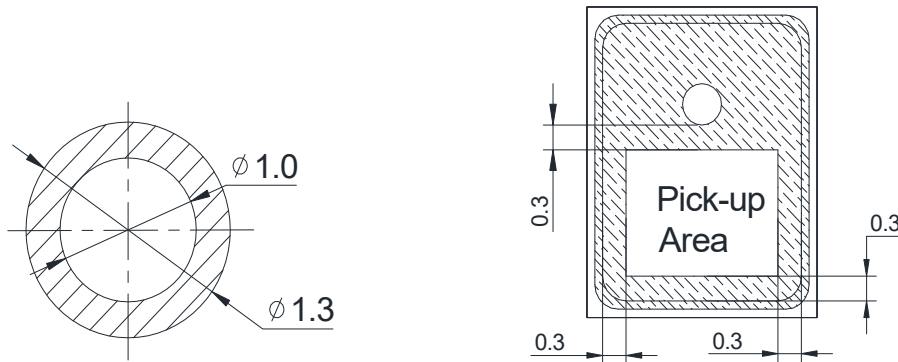


Fig. 14 Recommended nozzle for reflow MIC and Pick-up Area

Special Cautions

Air Rifle Cleaning Restriction

Do not bring air rifle to the port hole directly.

Recommended Condition:

Air pressure < 0.3MPa;

Distance > 5cm;

Time < 5 sec.

Package

Do NOT vacuum seal unused material for storage. Vacuum Sealing can cause mic damage.

Storage

The component needs to meet the requirement of MSL(Moisture Sensitivity Level) class 1. Please keep MICs in warehouse with humidity less than 75% and without sudden temperature change, acid air, and any other harmful air or strong magnetic field.

Please protect products against moist, shock, sunburn and pressure.

Please take proper measures against ESD in the process of assembly and transportation.

Please use the shipping package for long-term storage.

Discard

For microphones to be wasted, customer shall follow the regulation of Waste Electrical and Electronic Equipment (WEEE) Directive (2002/96/EC).

Notes: More application suggestions can be found in the latest "MEMS Microphone Application Notes".

Specification Revisions

| Date | Version | Description |
|------------|---------|-----------------------------------|
| 04-20-2021 | V1.0 | Initial release |
| 05-28-2021 | V2.0 | Updated Electrical Specifications |
| 06-22-2021 | V3.0 | Updated Electrical Specifications |
| 09-08-2022 | V4.0 | Updated SNR limit |
| 12-15-2022 | V5.0 | Updated marking information |
| 05-18-2023 | V6.0 | Updated reflow specification |
| 05-13-2024 | V7.0 | Updated Output load |
| 07-31-2025 | V8.0 | Updated Gettop information |
| | | |
| | | |
| | | |

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